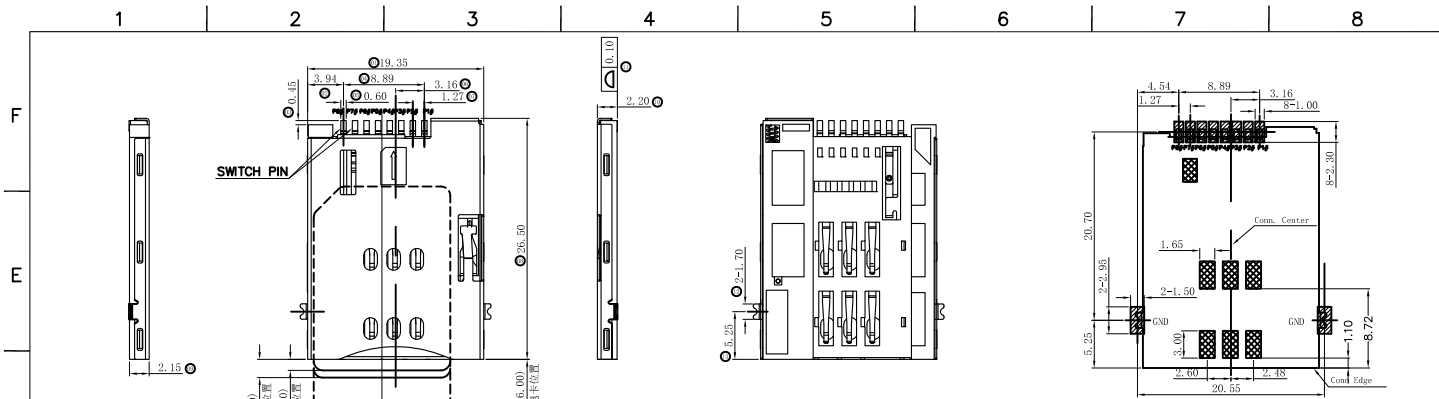
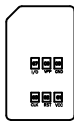




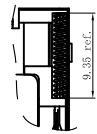
RECOMMENDED PCB LAYOUT(TOP VIEW)
GENERAL TOLERANCES: ±0.05
 SOLDER AREA
 NINE CIRCUIT DIAGRAM AREA

F
E
D
C
B
A

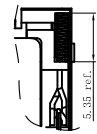
PIN NO.	DESCRIPTION
P1#	C1: VCC
P2#	C5: GND
P3#	C2: RST
P4#	C6: VPP
P5#	C3: CLK
P6#	C7: I/O
P7#	POL
P8#	DET



SIM 示意图
芯片面侧下视图



预压状态



工作状态

NOTES:
 1) MATERIAL:
 HOUSING: LCP UL 94V-0
 CONTACT: CS210, T=0.15mm
 SHELL: SUS304, T=0.20mm
 MYLAR: POLYESTER
 2) FINISH :
 CONTACT: GOLD FLASH PLATED ON CONTACT AREA;
 GOLD FLASH PLATING ON SOLDER TAILS, WITH
 ENTIRE CONTACT UNDERPLATED 50u"Min. NICKEL
 SHELL: 50u"Min. NICKEL UNDERPLATED OVERALL ,
 GOLD FLASH PLATED ON SOLDER TAILS
 3) INFRARED REFLOW SOLDERING: 10sec. Min. at 260°C±10°

REV.	ECN. NO.	DRAWN	DATE	EC.content
A.0	NEW	Candy	09/25/2020	-



HSF
Compliant

QUALITY CONTROL ITEM	GENERAL TOLERANCE	PART NO.:
APPROVED	X±0.38 X'±2° XX±0.25 X'±1° XXX±0.13	WK-3016
CHECKED		TITLE: PUSH SIM CARD 6+2PIN 2.20H
DRAWN	UNIT: mm	SCALE: 1:1
		SHEET: 1/1
		REV.: A.0